



CyberOptics Demonstrates Yield-Improving Auto Vibration and Leveling Sensor at SEMICON Europa

Minneapolis, Minnesota — October, 2019 — [CyberOptics® Corporation](http://www.cyberoptics.com) (NASDAQ: CYBE), a leading global developer and manufacturer of high-precision 3D sensing technology solutions, will exhibit at SEMICON Europa from November 12-15, 2019 at the Messe Munchen in booth #B1101. During the show, the company will demonstrate its new WaferSense® Auto Vibration and Leveling Sensor™ (AVLS3) with CyberSpectrum™ software for semiconductor tool set-up and diagnostics.

At only 3.5mm, AVLS3 can travel with ease to most fab locations where a wafer travels. The Chemically Hardened Glass (CHG) substrate enables smooth wafer handling and improved vacuum chucking.

With long-range wireless capability, AVLS3 combined with new, easy-to-use CyberSpectrum software, collects and displays both leveling and vibration data simultaneously for fast equipment set-up, alignment and real-time equipment diagnostics.

AVLS3 can speed equipment qualification, shorten equipment maintenance cycles and lower equipment maintenance expenses. Semiconductor engineers can also enhance process uniformity with the objective and reproducible data.

CyberOptics will also demonstrate the WaferSense Airborne Particle Sensor (APS3) that is recognized by semiconductor fabs as the Best Known Method (BKM) for wirelessly detecting and monitoring airborne particles in real-time.

Semiconductor fabs and equipment OEMs worldwide have adopted WaferSense devices to significantly improve yields and increase tool uptime.

For more information, visit www.cyberoptics.com.

About CyberOptics

CyberOptics Corporation (www.cyberoptics.com) is a leading global developer and manufacturer of high-precision 3D sensing technology solutions. CyberOptics' sensors are used for inspection and metrology in the SMT and semiconductor capital equipment markets to significantly improve yields and productivity. By leveraging its leading edge technologies, the Company has strategically established itself as a global leader in high precision 3D sensors, allowing CyberOptics to further increase its penetration of key vertical markets. Headquartered in Minneapolis, Minnesota, CyberOptics conducts worldwide operations through its facilities in North America, Asia and Europe.



Statements regarding the Company's anticipated performance are forward-looking and therefore involve risks and uncertainties, including but not limited to: market conditions in the global SMT and semiconductor capital equipment industries; the timing of orders and shipments of our products, particularly our 3D MRS-enabled AOI systems; increasing price competition and price pressure on our product sales, particularly our SMT systems; the level of orders from our OEM customers; the availability of parts required to meet customer orders; unanticipated product development challenges; the effect of world events on our sales, the majority of which are from foreign customers; rapid changes in technology in the electronics and semiconductor markets; product introductions and pricing by our competitors; the success of our 3D technology initiatives; the market acceptance of our SQ3000 3D CMM system, products for semiconductor wafer level and advanced packaging inspection and metrology and CyberGage360 product; costly and time consuming litigation with third parties related to intellectual property infringement; and other factors set forth in the Company's filings with the Securities and Exchange Commission.

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